AMENDMENTS TO THE CLAIMS

This listing of claims will replace all prior versions and listings of claims in the application.

2

1. (Currently amended) A method of depositing a glass-likenon-polymeric dielectric coating having at least one coating layer onto a substrate that includes at least one non-planar surface, wherein the non-planar surface comprises at least one interior or exterior corner, the method comprising the steps of:

forming a glass-like coating, wherein the glass-like coating is comprised of at least one coating layer; and

depositing, via ion plating deposition, the at least one coating layer onto a-the substrate having at least one non-planar surface comprising at least one interior or exterior corner, such that each of the at least one coating layer layers is conformal throughout on the surface of the substrate, including throughout each of the at least one non-planar surface.

- 2. (Currently amended) The method of claim 1, wherein the step of depositing the at least one coating layer onto a substrate is accomplished such that each of the at least one coating layer layers has a predetermined thickness, wherein the sum of the thicknesses of each of the at least one coating layer the layers is in the range of about 5 nanometers to 5000 nanometers.
- 3. (Currently amended) The method of claim 32, wherein the sum of the thicknesses of each of the at least one coating layer is in the range of about 10 nanometers to 1000 nanometers.
- 4. (Original) The method of claim 1, wherein each of the at least one non-planar surface is selected from the group consisting of at least one grating, at least one undulating surface, at least one well, and at least one stepped surface.

Amendment dated March 26, 2008 Reply to Office Action of September 26, 2007

- 5. (Original) The method of claim 1, wherein the at least one coating layer is a thin film.
- 6. (Original) The method of claim 5, wherein the at least one coating layer is an oxide thin film.
- 7. (Original) The method of claim 6, wherein the at least one coating layer is a metal oxide thin film.
- 8. (Original) The method of claim 1, wherein the coating is comprised of a plurality of coating layers.
- 9. (Original) The method of claim 8, wherein the plurality of coating layers includes a plurality of alternating metal oxide layers.
- 10. (Currently amended) The method of claim 1, wherein the step of forming a coating layer includes introducing a coating material in the form of a reagent for forming the coating layer.
- 11. (Currently amended) The method of claim 10, wherein the reagent is comprises an element selected from the group consisting of silicon, titanium, aluminum, tantalum, hafnium and zirconium.
- 12. (Currently amended) The method of claim 1, wherein the substrate is selected from the group consisting of a glass substrate, a metal substrate, a plastic substrate, and a semiconductor substrate, and an electronic device substrate.
- 13. (Currently amended) The method of claim 1, wherein the substrate is positioned in an ion plating coating apparatus during the formation step, the coating apparatus comprising:

a-an evacuatable coating vessel capable of being evacuated to a reduced pressure;

an ion plating deposition plasma source; and at least one associated electron beam gun.

14. (Withdrawn) A substrate, comprising:

at least one non-planar surface coated with a glass-like coating, wherein the glass-like coating includes at least one coating layer, and wherein each of the at least one coating layer is conformal throughout each of the at least one non-planar surface of the substrate.

- 15. (Withdrawn) The substrate of claim 14, wherein each of the at least one coating layer has a predetermined thickness, and wherein the sum of the thicknesses of each of the at least one coating layer is in the range of about 5 nanometers to 5000 nanometers.
- 16. (Withdrawn) The substrate of claim 15, wherein the sum of the thicknesses of each of the at least one coating layer is in the range of about 10 nanometers to 1000 nanometers.
- 17. (Withdrawn) The substrate of claim 14, wherein the substrate is selected from the group consisting of a glass substrate, a metal substrate, a plastic substrate, a semiconductor substrate, and an electronic device substrate.
- 18. (Withdrawn) The substrate of claim 14, wherein each of the at least one non-planar surface is selected from the group consisting of at least grating, at least one undulating surface, at least one well, and at least one stepped surface.
- 19. (Withdrawn) The substrate of claim 14, wherein the at least one coating layer is a thin film.

Application No. 10/782,042 5 Docket No.: 60158(70919) Amendment dated March 26, 2008

Reply to Office Action of September 26, 2007

20. (Withdrawn) The substrate of claim 19, wherein the at least one coating layer is an oxide thin film.

- 21. (Withdrawn) The substrate of claim 20, wherein the at least one coating layer is a metal oxide thin film.
- 22. (Withdrawn) The substrate of claim 14, wherein the coating is comprised of a plurality of coating layers.
- 23. (New) The method of claim 1, wherein the non-polymeric dielectric coating comprises an oxide material or a nitride material.